G4L3-ZD1-LAX3

HPC/AI Server - 4U DP HGX™ H200 8-GPU DLC









Features

- Liquid-cooled NVIDIA HGX™ H200 8-GPU
- CPU+GPU direct liquid cooling solution with leak detection
- 900GB/s GPU-to-GPU bandwidth with NVLink® and NVSwitch™
- Dual AMD EPYC™ 9005/9004 Series Processors
- 12-Channel DDR5 RDIMM, 24 x DIMMs
- **Dual ROM Architecture**
- Compatible with NVIDIA BlueField®-3 DPUs and ConnectX®-7 NICs
- 2 x 10Gb/s LAN ports via Intel® X710-AT2
- 2 x M.2 slots with PCIe Gen3 x4 and x1 interface
- 8 x 2.5" Gen5 NVMe hot-swap bays
- 4 x FHHL dual-slot PCle Gen5 x16 slots
- 8 x FHHL single-slot PCle Gen5 x16 slots
- 4+4 3000W 80 PLUS Titanium redundant power supplies

Specification

Dimensions	4U (W447 x H175.3 x D900 mm)	I/O Ports	Front: 2 x USB 3.2 Gen1, 1 x VGA, 2 x RJ45, 1 x MLAN (default) Rear: 1 x MLAN
Motherboard	MSB3-PE0		· · · · · · · · · · · · · · · · · · ·
Modular GPU	Liquid-cooled NVIDIA HGX™ H200 with 8 x SXM GPUs	Backplane Board	Speed and bandwidth: PCle Gen5 x4
CPU	AMD EPYC™ 9005 Series Processors AMD EPYC™ 9004 Series Processors Dual processor, cTDP up to 500W	TPM	1 x TPM header with SPI interface - Optional TPM2.0 kit: CTM010
Socket	2 x LGA 6096 (Socket SP5)	Power Supply	4+4 3000W 80 PLUS Titanium redundant power supplies AC Input: 115-240V *The system power supply requires C19 power cord.
Chipset	System on Chip	System	ASPEED® AST2600 Baseboard Management Controller
Memory	12-Channel DDR5 RDIMM, 24 x DIMMs [EPYC 9005] Up to 6000 MT/s [EPYC 9004] Up to 4800 MT/s	Management	GIGABYTE Management Console web interface
		OS Support	Windows Server, Red Hat Enterprise Linux Server, VMware ESXi, SUSE Linux Enterprise, Ubuntu Server, Citrix Hypervisor
LAN	2 x 10Gb/s LAN ports (1 x Intel® X710-AT2) - Support NCSI function 1 x 10/100/1000 management LAN	System Fans	Motherboard: 2 x 60x60x56mm, 2 x 60x60x76mm PCle slots: 4 x 80x80x56mm (15,500rpm)
Video	Integrated in ASPEED® AST2600 - 1 x VGA port		GPU tray: 4 x 60x60x38mm (24,000rpm)
Storage	Front hot-swap: 8 x 2.5" Gen5 NVMe Internal M.2: 1 x M.2 (2280/22110), PCIe Gen3 x4	Operating Properties	Operating temperature: 10°C to 35°C Operating humidity: 8-80% (non-condensing) Non-operating temperature: -40°C to 60°C Non-operating humidity: 20%-95% (non-condensing)
	1 x M.2 (2280/22110), PCIe Gen3 x1	Packaging Content	1 x G4L3-ZD1-LAX3, 1 x CPU cold plate loop, 1 x L-shape Rail kit
RAID	Require RAID add-in cards		
Expansion Slots	4 x FHHL dual-slot PCIe Gen5 x16 slots 8 x FHHL single-slot PCIe Gen5 x16 slots	Part Numbers	Barebone w/ NVIDIA module: 6NG4L3ZD1DR000LCX3*



Learn more at https://www.GIGABYTE.com/enterprise

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